



Website: www.displaytech.com.hk

LCD Module

Product Specification

Product: 162B Series (16 Characters x 2 Lines)

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15 April 2009.

REVISION RECORD

| VERSION | CHANGES | DATE |
|----------------|--|------------------|
| 2.0 | IC changed, and spec format changed | 16 February 2009 |
| 2.1 | Soldering iron temperature on page 21 was changed to 310°C | 15 April 2009 |
| | | |
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1. GENERAL SPECIFICATION

| Item | Contents |
|-------------------------|---|
| Display Format | 16 Characters x 2 Lines |
| Character matrix (W×H) | 5 × 8 Dots |
| Character size (W×H) | 2.95mm x 5.55mm |
| Dot size (W×H) | 0.55mm x 0.65mm |
| Dot pitch (W×H) | 0.60mm x 0.70mm |
| View Area | 65.6mm x 16.0mm |
| Module Size | 84.0mm x 44.0mm x 11.0mm MAX (14.0mm MAX w/LED backlight) |
| LCD Type | TN / STN / FSTN |
| Polarizer Mode | Reflective / Transflective / Transmissive |
| View Angle | 6 o'clock / 12 o'clock |
| Backlight | LED / EL |
| Backlight Driver Type | External Power |
| Backlight Color | Yellow Green / White / Blue / Pure Green / Amber |
| Controller & LCD Driver | ST7066U-0A-B & ST7065C |
| Driving Method | 1/16 Duty, 1/5Bias |

2. ABSOLUTE MAXIMUM RATINGS

(Ta=25°C VSS=0V)

| ITEM | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|--|-----------------|------|------|---------|------|
| Power Supply for Logic | VDD | -0.3 | --- | 7.0 | V |
| Power Supply for LCD | VDD - V0 | -0.3 | --- | 15.0 | V |
| Input Voltage | V _{IN} | -0.3 | --- | VDD+0.3 | V |
| Normal Operating Temperature | Top | 0 | --- | 50 | °C |
| Normal Storage Temperature | Tst | -10 | --- | 60 | °C |
| Wide operating / storage temperature (except FSTN) | TOP / TST | -30 | --- | 80 | °C |
| Wide operating / storage temperature (FSTN) | TOP / TST | -30 | --- | 70 | °C |

3. ELECTRICAL CHARACTERISTICS

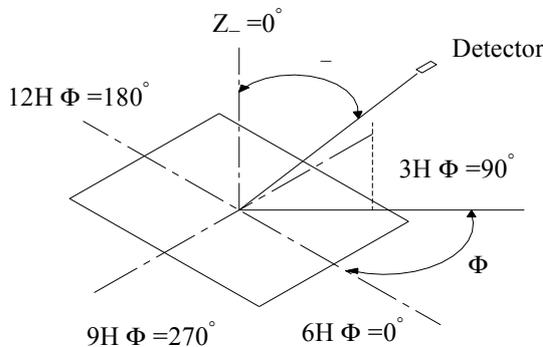
(Ta=25°C, VDD=5.0V±5%)

| ITEM | SYMBOL | CONDITION | MIN. | TYP. | MAX. | UNIT |
|----------------------------|-----------------|-----------|-----------------|------|-----------------|------|
| Power Supply for LCM | VDD | --- | 4.75 | 5.0 | 5.25 | Volt |
| Input Voltage | V _{IL} | L level | V _{SS} | --- | 0.2VDD | Volt |
| | V _{IH} | H level | 0.8VDD | --- | V _{DD} | Volt |
| LCD Driver Driving Voltage | V0-VSS | --- | --- | --- | --- | Volt |
| | | 25°C | --- | 4.5 | --- | |
| | | --- | --- | --- | --- | |
| Supply Current for LCM | IDD | VDD=5.0V | --- | 4.5 | --- | mA |
| | Ie * | --- | --- | --- | --- | |

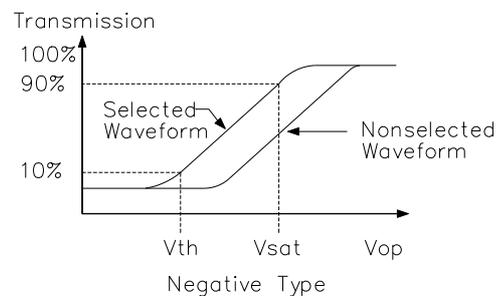
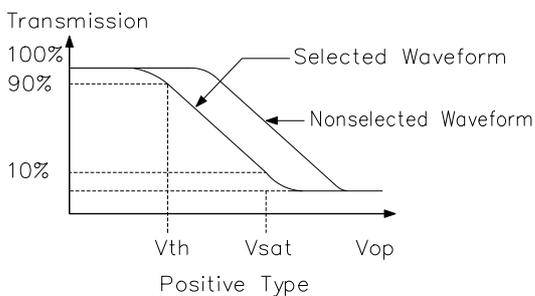
4. ELECTRO-OPTICAL CHARACTERISTICS

| NO | Item | Symbol | Measuring Condition | STD.Value | | | | Unit | Remark |
|--------------------|-------------------------------|--------|-------------------------|--------------------|-------------------------|------|------------------|------|----------------|
| | | | | °C | Min | Typ | Max | | |
| 1 | Recommended Operating Voltage | VLCD | $_ = 0$ $\Phi = 0$ | 25 | --- | 5.0 | --- | V | Note1 Note2 |
| 2 | Operating Voltage | Vth | $_ = 0$ $\Phi = 0$ | 0 | --- | --- | --- | | |
| | | | | 25 | --- | 1.30 | --- | | |
| | | Vsat | $_ = 0$ $\Phi = 0$ | 0 | --- | --- | --- | | |
| | | | | 25 | --- | 1.45 | --- | | |
| 3 | Response time | Tr | $_ = 0$ $\Phi = 10$ | 0 | --- | --- | --- | | |
| | | | | 25 | --- | 97 | --- | | |
| | | | | 50 | --- | --- | --- | | |
| | | | | Tf | $_ = 0$ $\Phi = 10$ | 0 | --- | --- | --- |
| | | 25 | --- | | | 56 | --- | | |
| | | 50 | --- | | | --- | --- | | |
| | | 4 | Viewing Angle (Cr□2) | | | - | $\Phi = 0^\circ$ | 25 | --- |
| | | | | $\Phi = 180^\circ$ | 25 | | | --- | 30 |
| $\Phi = 90^\circ$ | 25 | | | --- | 25 | | | --- | |
| $\Phi = 270^\circ$ | 25 | | | --- | 25 | | | --- | |
| 5 | Current Consumption | ILCD | Hz=64 | 25 | --- | 10.4 | --- | uA | Note3 |

NOTE 1: DEFINITION OF VIEWING ANGLE AND DIRECTION



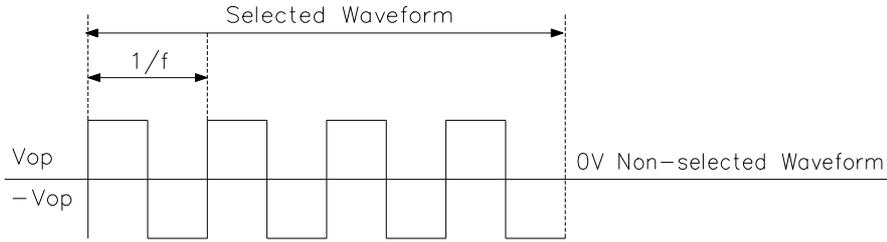
NOTE 2: THERSHOLD VOLTAGE AND SATURATION VOLTAGE



Vth: The voltage Vop which the transmission rate of segment is 90%(positive) or 10%(negative) of saturated value on conditions of the selected waveform.(non-selected waveform is opposition)

Vsat: The voltage Vop which the transmission rate of segment is 10%(positive) or 10%(negative) of saturated value on conditions of the selected waveform.(non-selected waveform is opposition)

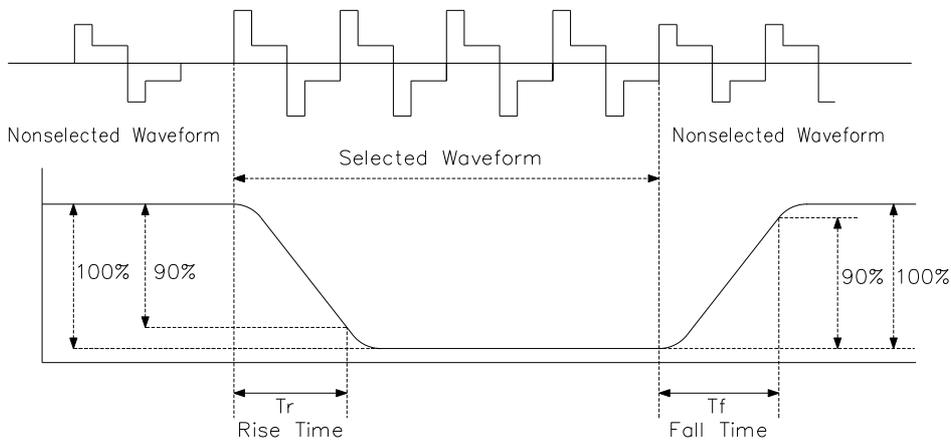
NOTE 3: CURRENT CONSUMPTION (I_{LCD})



Conditions:

- 1. Driving waveform: static waveform.
- 2. Voltage applied to all segments

NOTE 4: RESPONSE TIME (T_r, T_f)



NOTE 5: CONTRAST RATIO (CR)

5.1 POSITIVE TYPE:

$$\text{CONTRAST RATIO} = \frac{\text{BRIGHTNESS AT VOP(NON-SELECTED)}}{\text{BRIGHTNESS AT VOP(SELECTED)}}$$

5.2 NEGATIVE TYPE:

$$\text{CONTRAST RATIO} = \frac{\text{BRIGHTNESS AT VOP(SELECTED)}}{\text{BRIGHTNESS AT VOP(NON-SELECTED)}}$$

NOTE 6: CAPACITANCE (C)

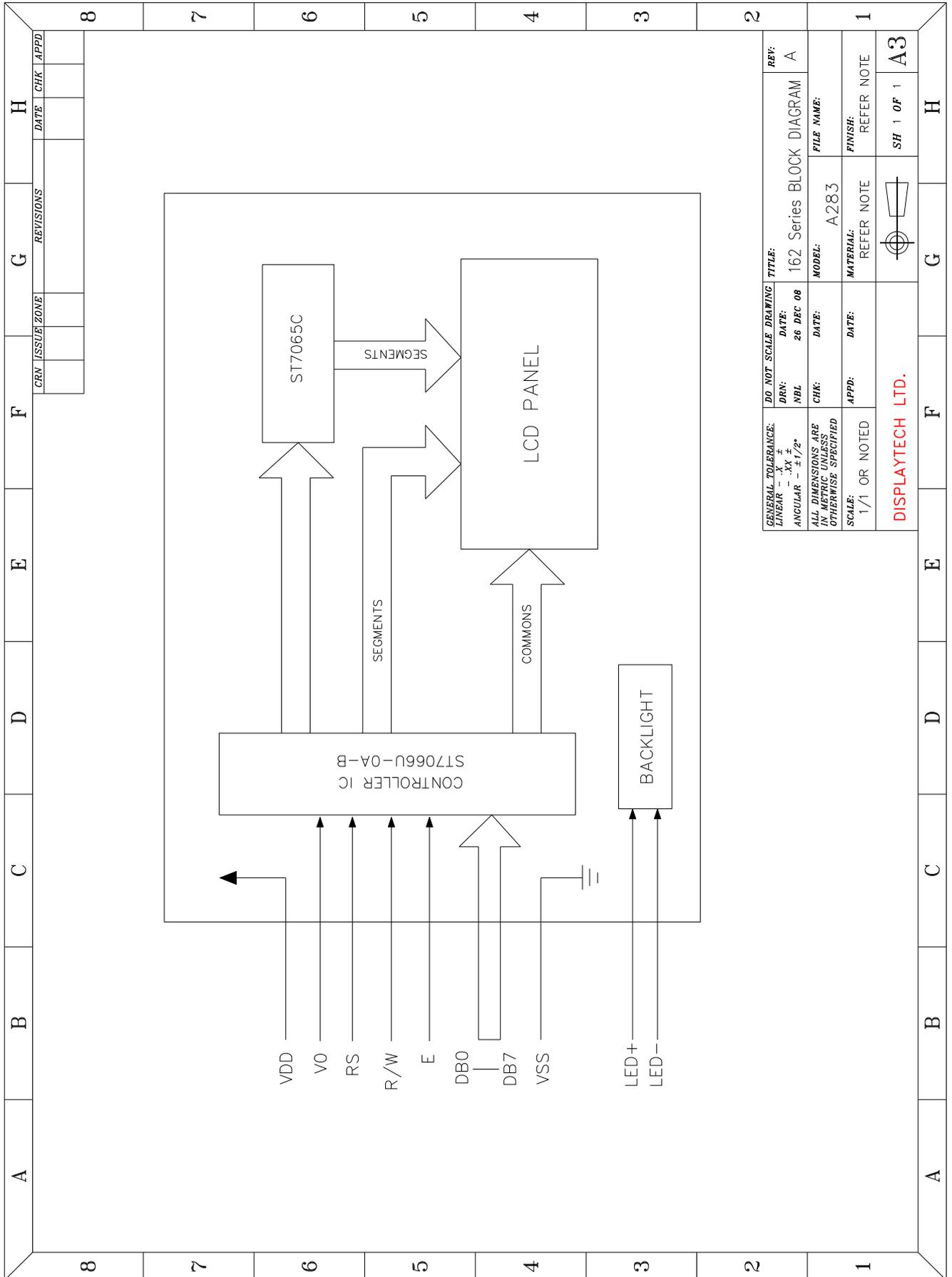
Measuring Methode Of Capacitance



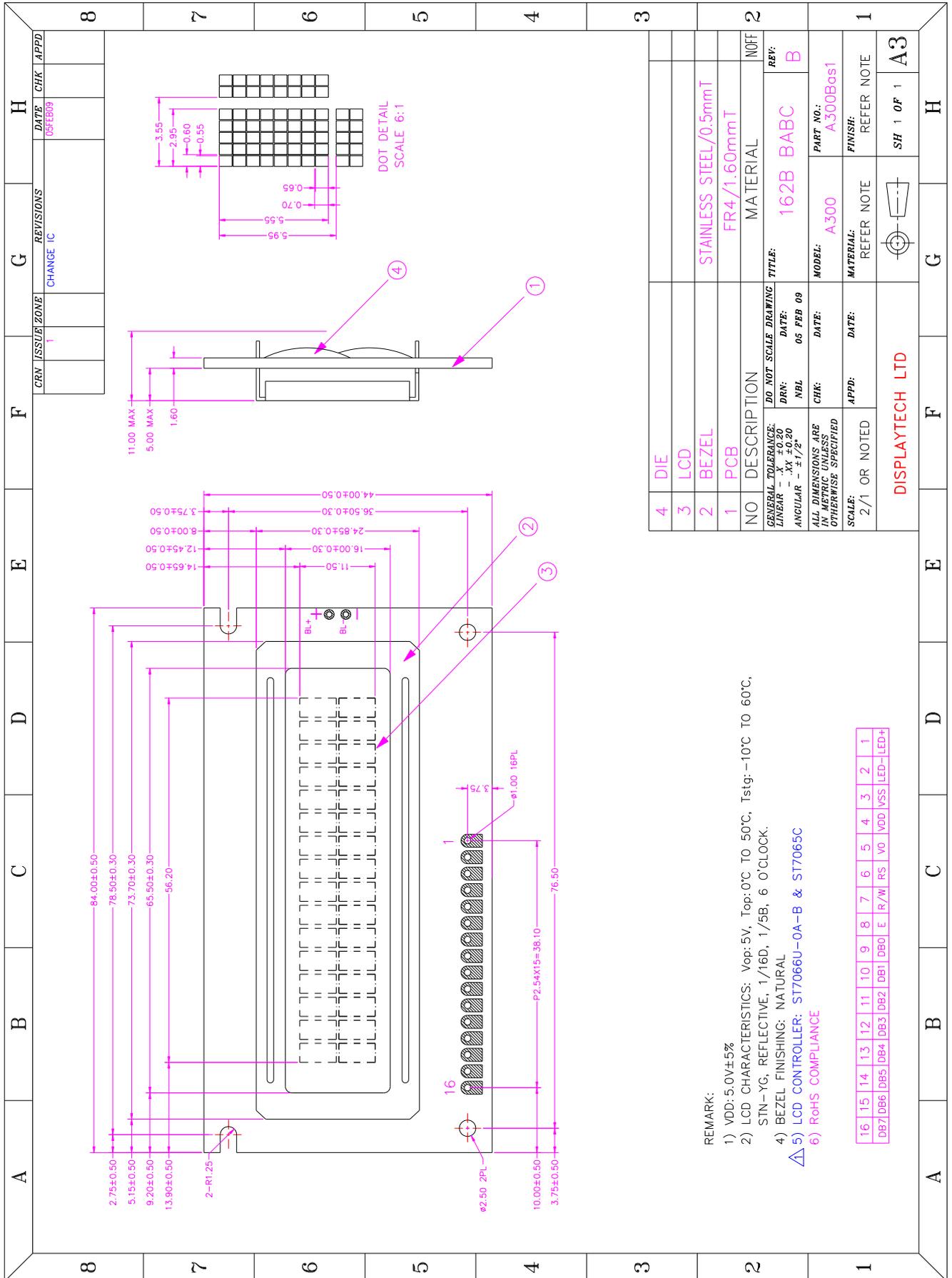
Conditions:

Voltage applied to all segments.

5. BLOCK DIAGRAM

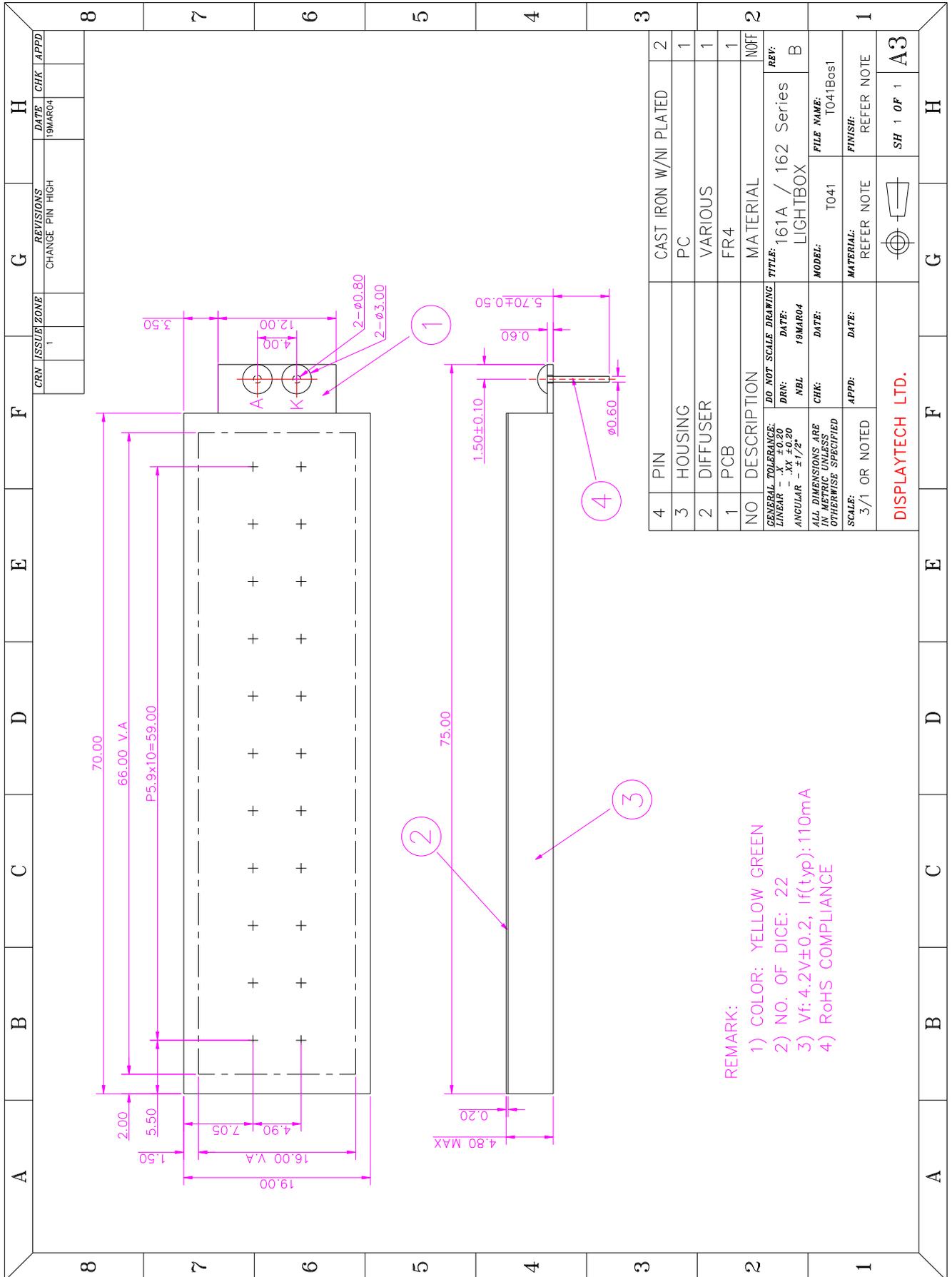


6.2. Without Backlight

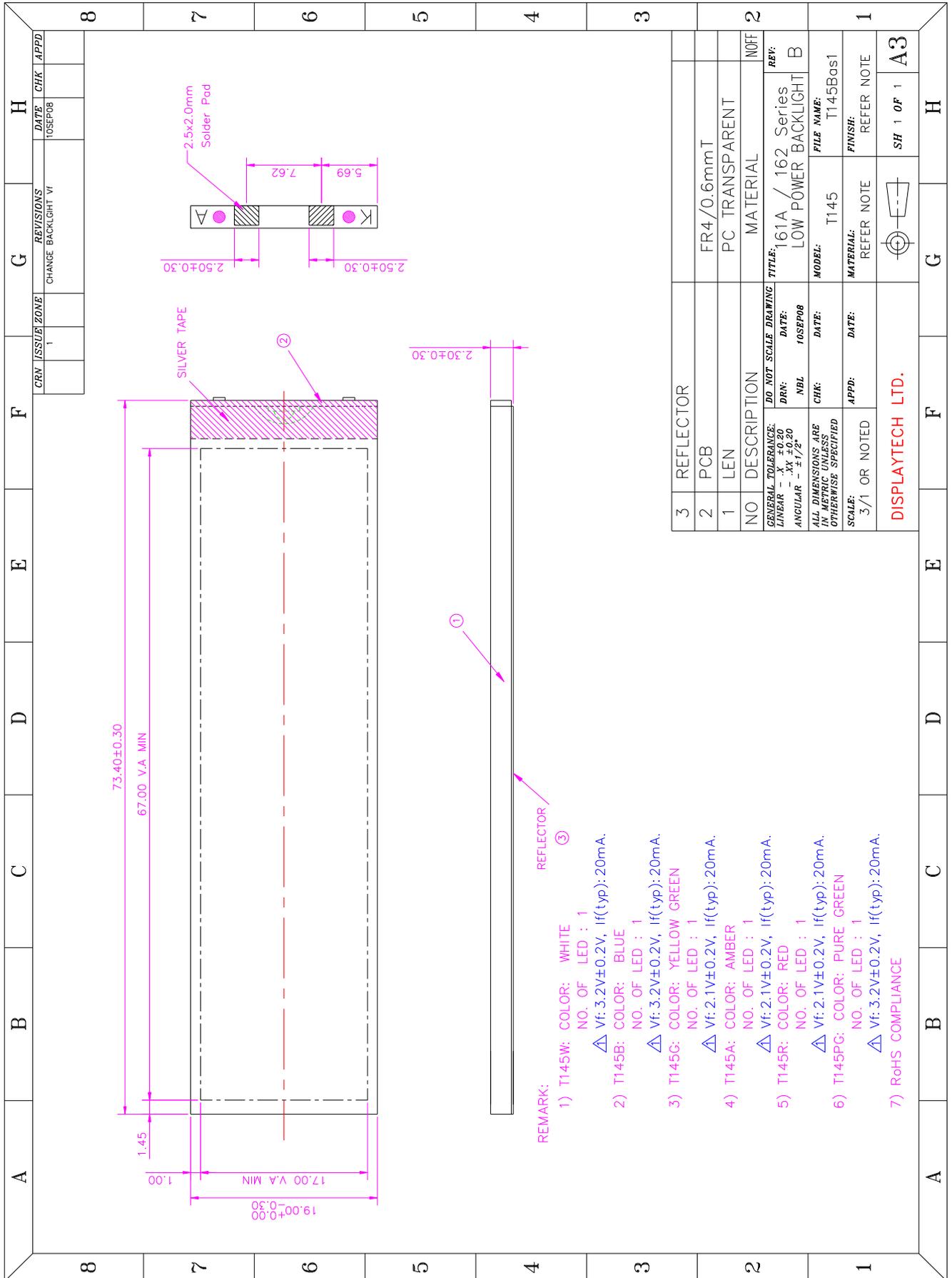


7. BACKLIGHT DRAWING

7.1. Lightbox Type Backlight (Yellow Green in color)



7.2. Low Power Type Backlight (White / Blue / Pure Green in color)



8. BACKLIGHT SPECIFICATION

8.1. LIGHTBOX TYPE BACKLIGHT (YELLOW GREEN IN COLOR)

8.1.1. Mechanical Specifications

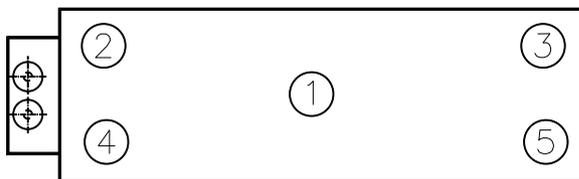
| ITEM | NOMINAL DIMENSIONS | UNIT |
|--------------------------|--------------------|------|
| OUTLINE SIZE (LxWxH) | 75x19x4.8MAX. | mm |
| VIEWING AREA (LxW) | 66.0x16.0 | mm |
| CONTACT PIN PITCH/LENGTH | P=4.0/L=7.0 | mm |
| NO.OF LED SMT | 22 | --- |

8.1.2. Electrical/Optical Characteristics (Ta=25°C, If=110mA typ.)

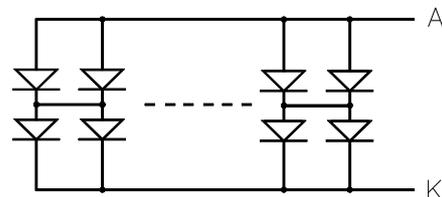
| MODE | PARAMETER | UNIT |
|---------------------------------|--------------|-------------------|
| COLOR | YELLOW GREEN | --- |
| WAVE LENGTH | 568 | nm |
| AVERAGE LUMINOUS INTENSITY (IV) | 143 typ | cd/m ² |
| FORWARD VOLTAGE (Vf) | 4.2 typ | V |

8.1.3. Absolute Maximum Rating

| ITEM | VALUE | SYMBOL |
|-----------------------|---------------|--------|
| FORWARD CURRENT | 165mA | If |
| REVERSE VOLTAGE | 5V | Vr |
| POWER DISSIPATION | 693mW | Pd |
| OPERATING TEMPERATURE | -20°C TO 70°C | Top |
| STORAGE TEMPERATURE | -30°C TO 80°C | Tstg |



TESTING POINT



CIRCUIT DIAGRAM

REMARK:

1. AVERAGE LUMINOUS INTENSITY IS THE AVERAGE VALUE OF THE FIVE INDICATED POINTS AS SHOWN.
2. MEASUREMENT INSTRUMENT: BM-7, APERTURE: 5mm.

8.2. LOW POWER TYPE BACKLIGHT (WHITE / BLUE / PURE GREEN IN COLOR)

8.2.1. Mechanical Specifications

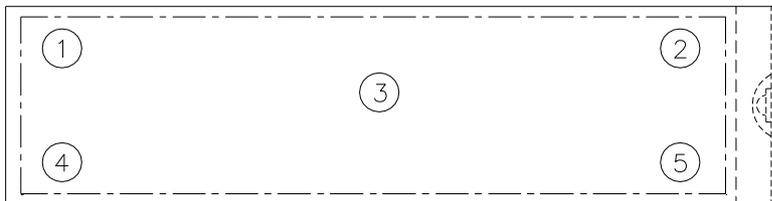
| ITEM | NOMINAL DIMENSIONS | UNIT |
|--------------------------|--------------------|------|
| OUTLINE SIZE (LxWxH) | 73.4x19.0x2.3 | mm |
| VIEWING AREA (LxW) | 67.0x17.0 | mm |
| CONTACT PIN PITCH/LENGTH | NIL | mm |
| NO.OF LED SMT | 1 | --- |

8.2.2. Electrical/Optical Characteristics (Ta=25°C, If=20mA typ.)

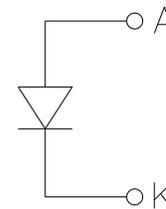
| MODE | PARAMETER | | | UNIT |
|---------------------------------|-----------|----------|------------|-------------------|
| COLOR | WHITE | BLUE | PURE GREEN | --- |
| WAVE LENGTH | --- | 470 | 520 | nm |
| AVERAGE LUMINOUS INTENSITY (IV) | 198 typ | 10.5 typ | 31 typ | cd/m ² |
| FORWARD VOLTAGE (Vf) | 3.2 typ | | | V |

8.2.3. Absolute Maximum Rating

| ITEM | VALUE | SYMBOL |
|-----------------------|---------------|--------|
| FORWARD CURRENT | 30mA | If |
| REVERSE VOLTAGE | 5V | Vr |
| POWER DISSIPATION | 96 mW | Pd |
| OPERATING TEMPERATURE | -20°C TO 70°C | Top |
| STORAGE TEMPERATURE | -30°C TO 80°C | Tstg |



TESTING POINT



CIRCUIT DIAGRAM

REMARK:

1. AVERAGE LUMINOUS INTENSITY IS THE AVERAGE VALUE OF THE FIVE INDICATED POINTS AS SHOWN.
2. MEASUREMENT INSTRUMENT: BM-7, APERTURE: 10mm.

9. QUALITY GUARANTEE

9.1. PURPOSE: It is to define the inspection standard of LCD modules

9.2. PRODUCT STANDARD

1) INSPECTION AND TEST

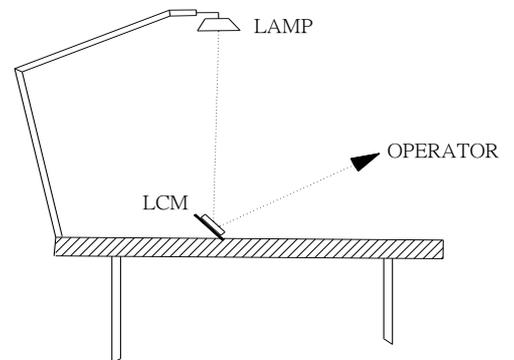
- FUNCTION TEST
- APPEARANCE INSPECTION
- PACKING SPECIFICATION

2) INSPECTION CONDITION

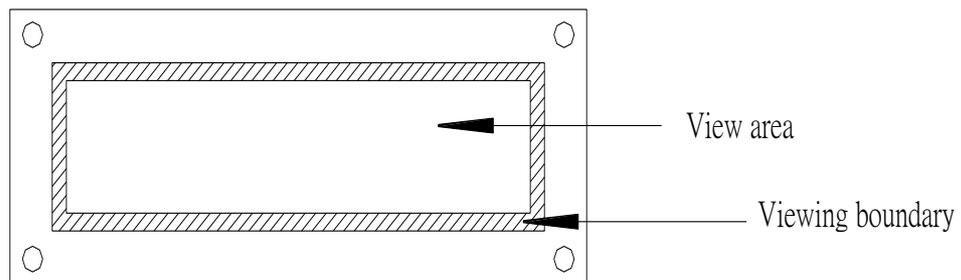
- Put under the lamp (20w×2) at a distance 100mm from the LCD Modules.
- Tilt upright 45 degree by the front (back) to inspect LCD appearance.

3) AQL INSPECTION LEVEL

- SAMPLING METHOD : MIL-STD-105D
- SAMPLING PLAN : SINGLE
- MAJOR DEFECT : 0.65% (MAJOR)
- MINOR DEFECT : 2.5% (MINOR)
- GENERAL LEVEL : II/NORMAL

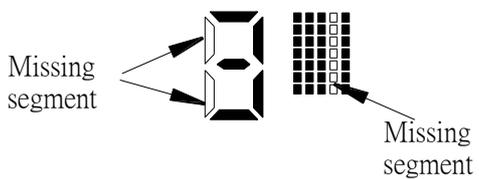
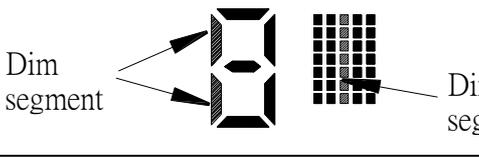
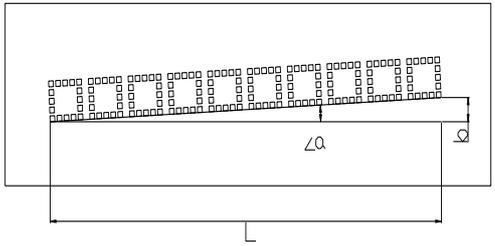
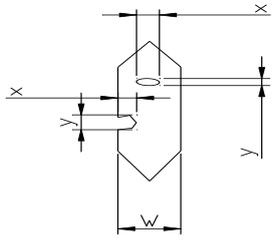


9.3. DISPLAY AREA DEFINITION:



9.4. INSPECTION STANDARD

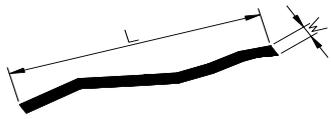
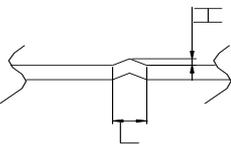
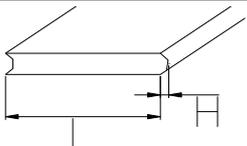
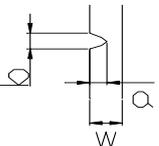
1) FUNCTIONAL TEST STANDARD

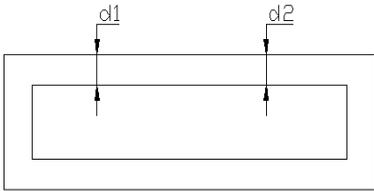
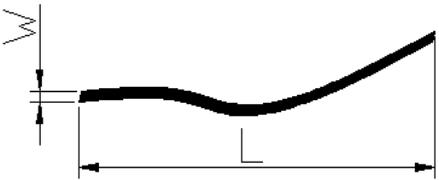
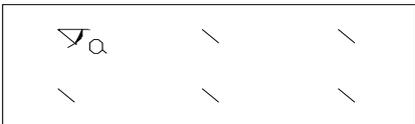
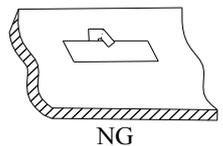
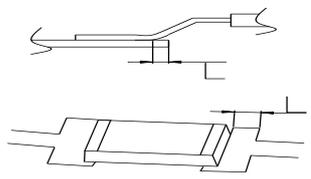
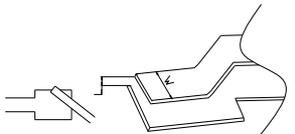
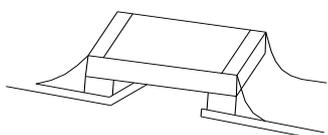
| Item | Inspection Standard Description | | Standard | Defect type | |
|---------|--|---|---------------------------------|-------------|--------|
| 1 | LCD has no display | | Reject | MAJ | |
| 2 | LCM display do not change | | Reject | MAJ | |
| 3 | Display wrong pattern | | Reject | MAJ | |
| 4 | Display segment open |  | Reject | MAJ | |
| 5 | Display dim segment |  | Reject | MAJ | |
| 6 | Wrong LCD viewing direction | | Reject | MAJ | |
| 7 | Dim Display | | See sample | MAJ | |
| 8 | LCD color variation | | See sample | MAJ | |
| 9 | Pattern parallelism  | Acceptable range | | | |
| | | L | <a | b | |
| | | ≧ 20mm | 0.43° | ≧ 0.15mm | |
| | | ≧ 30mm | 0.38° | ≧ 0.2mm | |
| | | ≧ 40mm | 0.43° | ≧ 0.3mm | |
| | | ≧ 50mm | 0.40° | ≧ 0.35mm | |
| | | ≧ 60mm | 0.43° | ≧ 0.45mm | |
| | | ≧ 70mm | 0.41° | ≧ 0.50mm | |
| | | ≧ 80mm | 0.43° | ≧ 0.60mm | |
| | | ≧ 90mm | 0.41° | ≧ 0.65mm | |
| ≧ 100mm | 0.43° | ≧ 0.75mm | | | |
| 10 | LCD display Pin hole |  | Standard | | |
| | | | $\varnothing = \frac{x + y}{2}$ | QTY | |
| | | | $\varnothing \leq 0.25$ | 1 | Accept |
| | | | $\varnothing > 0.25$ | 1 | Accept |
| | | | $\varnothing < \frac{1}{4} W$ | 1 | Accept |
| | | $\varnothing > \frac{1}{4} W$ | 1 | Reject | MIN |

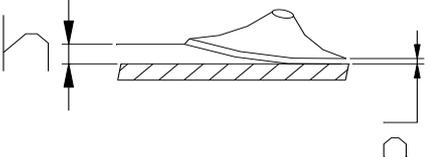
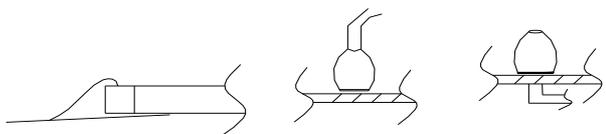
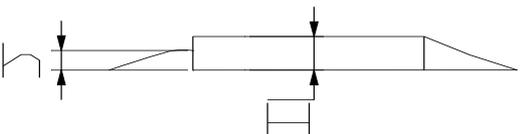
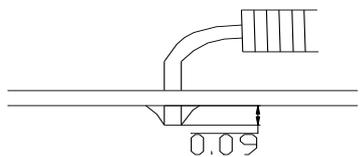
| Item | Inspection Standard Description | Standard | Defect type | | | |
|------|---|--|---------------------|--------|--------|-----|
| 11 | LCD display Broken segment(dots) | Draw | | | | |
| | | Standard | | | | |
| | | X | y | QTY | | |
| | | $\geq \frac{1}{4}b$ | $\geq \frac{1}{4}a$ | 1 | Reject | MIN |
| | | $(X \text{ or } y) \geq 0.2\text{mm}$ | | 1 | Reject | MIN |
| | | $\geq \frac{1}{4}b$ | $\geq \frac{1}{4}a$ | 1 | Accept | |
| | | $\geq \frac{1}{5}b$ | $\geq \frac{1}{5}a$ | 2 | Accept | |
| 12 | LCD display Black spot or White spot | $\varnothing = \frac{x+y}{2}$ | QTY | | | |
| | | $\varnothing < 0.10$ | | Accept | | |
| | | $0.1 < \varnothing \leq 0.20$ | 2 | Accept | | |
| | | $0.20 \leq \varnothing < 0.25$ | 1 | Accept | | |
| | | $0.25 < \varnothing \leq 0.4$ | 0 | Reject | MIN | |
| | | $\varnothing > 0.4$ | 0 | Reject | MAJ | |
| 13 | LCD display excess black line or white line | Black line/white line(Lxw)mm | QTY | | | |
| | | $(L \leq 1.0) \times (W \leq 0.025)$ | 2 | Accept | | |
| | | $(1.0 < L \leq 1.5) \times (W \leq 0.025)$ | 1 | Accept | | |
| | | $(L > 1.5) \times (W \leq 0.025)$ | 0 | Reject | MIN | |
| | | $(L > 2) \times (W > 0.025)$ | 0 | Reject | MAJ | |
| 14 | Backlight not function | | Reject | MAJ | | |
| 15 | LED not function or dim | | Reject | MIN | | |
| 16 | Backlight defect (dirt, scratch) | | Reject | MIN | | |

2) COSMETIC INSPECTION STANDARD

| Item | Standard description of inspection | Standard | Defect type | | | |
|----------|------------------------------------|----------------------------------|----------------|--------|--------|-----|
| 1 | LCD inspection item | | | | | |
| 1.1 | LCD color variation | See sample | MIN | | | |
| 1.2 | LCD broken | Reject | MAJ | | | |
| 1.3 | Wrong polarizer of LCD | Reject | MAJ | | | |
| 1.4 | Spot on LCD surface | Reject | MAJ | | | |
| 1.5 | Scratch on LCD | Scratch = \varnothing | QTY | | | |
| | | $\varnothing < 0.1$ | Except | Accept | | |
| | | $0.1 \leq \varnothing \leq 0.15$ | 2 | Accept | | |
| | | $0.15 < \varnothing \leq 0.25$ | 1 | Accept | | |
| | | $\varnothing > 0.25$ | 1 | Reject | MIN | |
| 1.6 | LCD scratch | Scratch = L | scratch = W | QTY | | |
| | | | $W \leq 0.015$ | | Accept | |
| | | < 0.5 | $W \leq 0.02$ | 2 | Accept | |
| | | < 1.0 | $W \leq 0.03$ | 1 | Accept | |
| | Scratch depth see sample | ≥ 1.0 | $W \geq 0.03$ | 1 | Reject | MIN |
| 1.7 | White or black spot on LCD | $\varnothing = \frac{x+y}{2}$ | QTY | | | |
| | | $\varnothing < 0.1$ | | Accept | | |
| | | $0.1 \leq \varnothing < 0.2$ | 2 | Accept | | |
| | | $0.2 \leq \varnothing \leq 0.25$ | 1 | Accept | | |
| | | $\varnothing > 0.25$ | 1 | Reject | MIN | |
| | Bevy point | - | Reject | MIN | | |

| Item | Standard description of inspection | | | Standard | Defect type | |
|----------|--|-----------------------------------|------------------------------|--------------------------|-------------|-----|
| 1.8 | Black line in LCD  | (L) | (W) | QTY | | |
| | | $L \leq 1.0$ | $W \leq 0.025$ | 2 | Accept | |
| | | $1.0 < L \leq 1.5$ | $W \leq 0.025$ | 1 | Accept | |
| | | $1.5 < L$ | $W > 0.025$ | 1 | Reject | MIN |
| 1.9 | Round air bubble | Size | QTY | | | |
| | | $\varnothing < 0.15$ | 2 | Accept | | |
| | | $0.15 \leq \varnothing \leq 0.25$ | 1 | Accept | | |
| 1.10 | Line defect | (L) | (W) | QTY | | |
| | | $L < 0.5$ | $W < 0.02$ | 2 | Accept | |
| | | $L < 1.0$ | $W < 0.03$ | 1 | Accept | |
| 1.11 | Finger print | | | 0 | Reject | MIN |
| 2 | PCB/COB specification | | | | | |
| 2.1 | PCB deformity  | L | H | | | |
| | | $\leq 6.0\text{mm}$ | $\leq 1.5\text{mm}$ | Accept | | |
| | | $> 6.0\text{mm}$ | $\leq 1.5\text{mm}$ | Reject | MIN | |
| | | $< 6.0\text{mm}$ | $> 1.5\text{mm}$ | Reject | MIN | |
| 2.2 | Deformity at PCB edge, damage circuit. | | | | Reject | MAJ |
| 2.3 | Convex at PCB edge  | L | H | | | |
| | | $\leq 6.0\text{mm}$ | $\leq 1.5\text{mm}$ | Accept | | |
| | | $> 6.0\text{mm}$ | $\leq 1.5\text{mm}$ | Reject | MIN | |
| | | $< 6.0\text{mm}$ | $> 1.5\text{mm}$ | Reject | MIN | |
| 2.4 | Damage excess 2x2mm at the PCB corner | | | | Reject | MIN |
| 2.5 | Scratch on PCB surface | | | | See sample | MIN |
| 2.6 | Scratch on PCB coat/leakage coat on PCB surface | | | | Reject | MAJ |
| 2.7 | Open circuit | | | | Reject | MAJ |
| 2.8 | PCB PTH open | | | | Reject | MAJ |
| 2.9 | Repair PCB PTH | | $QTY \leq 2\text{PCS}$ | Accept | | |
| | | | $QTY \geq 3\text{PCS}$ | Reject | MAJ | |
| 2.10 | Color different from one side to another side. | | | | Reject | MIN |
| 2.11 | Repaired solder mask area | | $\leq 30\text{mm}^2$ | Accept | | |
| | | | $\geq 30\text{mm}^2$ | Reject | MIN | |
| 2.12 | Scratch circuit, damage Circuit  | | $a \leq 1/2w$ or $b < w$ | Accept | | |
| | | | $a > 1/2w$ or $b > w$ | Reject | | |
| 3 | Bezel specification | | | | | |
| 3.1 | Wrong Materials | | | | | MAJ |
| 3.2 | Incorrect dimension | | | | | MAJ |
| 3.3 | Bezel broken | | | | | MAJ |
| 3.4 | Rust on Bezel | | | | | MAJ |
| 3.5 | Hole or dirty on oil Paint surface | Top surface | Size | cm^2/per | | |
| | | | $\varnothing \leq 0.3$ | 2 | Accept | |
| | | | $0.3 < \varnothing \leq 0.5$ | 1 | Accept | |
| | | Side | $\varnothing > 0.5$ | 0 | Reject | MIN |
| | | | $\varnothing \leq 0.5$ | 2 | Accept | |
| | | | $0.5 < \varnothing \leq 0.8$ | 1 | Accept | |
| | $\varnothing > 0.8$ | 0 | Reject | MIN | | |

| Item | Standard description of inspection | | Standard | Defect type | | | |
|-------------------------------|---|---|---|---------------|-------------|------------|--|
| 3.6 | Bezel bow or twist | $h \leq 0.01$ mm/mm | Accept | | | | |
| | | $h > 0.01$ mm/mm | Reject | MIN | | | |
| 3.7 |  | $d1 - d2 \leq \text{tolerance}$ | Accept | | | | |
| | | $d1 - d2 > \text{tolerance}$ | Reject | MIN | | | |
| 3.8 | Scratch on bezel |  | Face | | Accept QTY | See Sample | |
| | | | L | W | Not defined | | |
| | | | - | $W \leq 0.15$ | 2 | | |
| | | | $L \leq 3$ | $W \leq 0.20$ | 2 | | |
| | | | $L \leq 2$ | $W \leq 0.3$ | 2 | | |
| | | | - | $W > 0.3$ | | | |
| | | | side | | Accept QTY | | |
| | | | L | W | except | | |
| - | $W \leq 0.2$ | 2 | | | | | |
| $L \leq 3$ | $W \leq 0.25$ | 2 | | | | | |
| $L \leq 2$ | $W \leq 0.3$ | 2 | | | | | |
| 3.9 | Twist angle $\alpha = 45^\circ \pm 5^\circ$ |  | Accept | | | | |
| 3.10 | Void gap between bezel and PCB | | Reject | MIN | | | |
| 3.11 | Bezel clip incorrectly |  NG | Reject | MIN | | | |
| 4 Solder specification | | | | | | | |
| 4.1 | Wrong component | | Reject | MAJ | | | |
| 4.2 | Broken component | | Reject | MAJ | | | |
| 4.3 | Mis-alignment |  | Component legs extend beyond the pad and Legs > pad distance (w) on solder area > W^2 | Accept | | | |
| | | | Component legs extend beyond the pad and Legs > pad distance (w) on solder area < W^2 | Reject | MIN | | |
| 4.3 | Component Offset |  | Solder legs offset distance $L < \text{solder legs } 1/4W$ | Accept | | | |
| | | | Solder legs offset $L > 1/4W$ | Reject | MIN | | |
| 4.4 | Component assembly defect |  | Reject | MIN | | | |
| 4.5 | CHIP components hoist ≤ 0.5 mm | | Accept | | | | |
| 4.6 | CHIP components hoist > 0.5 mm | | Reject | MIN | | | |

| Item | Standard description of inspection | Standard | Defect type |
|----------|---|-----------------------|---------------|
| 4.7 | Components hoist | $h \leq 2.0\text{mm}$ | Accept |
| | | $h > 2.0\text{mm}$ | Reject MIN |
| 4.8 | Switch (socket) hoist | $h \leq 0.5\text{mm}$ | Accept |
| | | $h > 0.5\text{mm}$ | Reject MIN |
| 4.9 | Components cold solder or incomplete solder | Reject | MAJ |
| 4.10 | Solder PAD tilt up, but height (h) less than Solder PAD thickness (a)  | Accept | |
| 4.11 | Excess solder above components  | Reject | Min |
| 4.12 | Insufficient solder below components height or less than diameter  | Reject | MIN |
| 4.13 | Solder area less than soldering PAD Area by 2/3 | Reject | MIN |
| 4.14 | Trimmed pin length beyond 0.09inch (2.3mm)  | Reject | Min |
| 5 | Packing specification | | |
| 5.1 | Wrong carton mark. | Reject | MAJ |
| 5.2 | Carton mark problem | Reject | MIN |
| 5.3 | Carton damage extend than 150mm | Reject | MAJ |
| 5.4 | Carton damage, scratch more 50mm, less 150mm. | Reject | MIN |

10. PRECAUTIONS FOR USING LCD MODULES

10.1. HANDLING PRECAUTIONS

1. This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.
2. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
3. If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
4. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
5. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
6. If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol
7. Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
8. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
9. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
10. Do not attempt to disassemble or process the LCD module.
11. NC terminal should be open. Do not connect anything.
12. If the logic circuit power is off, do not apply the input signals.
13. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

10.2. POWER SUPPLY PRECAUTIONS:

1. Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
2. Prevent the application of reverse polarity to VDD and VSS, however briefly.
3. Use a clean power source free from transients. Power-up conditions are occasionally “jolting” and may exceed the maximum ratings of the modules.
4. The VDD power of the module should also supply the power to all devices that may access the display. Don’t allow the data bus to be driven when the logic supply to the module is turned off.

10.3. OPERATING PRECAUTIONS:

1. DO NOT plug or unplug the module when the system is powered up.
2. Minimize the cable length between the module and host MPU.
3. For models with EL backlights, do not disable the backlight by interrupting the HV line. Unload inverters produce voltage extremes that may arc within a cable or at the display.
4. Operate the module within the limits of the modules temperature specifications.

10.4. MECHANICAL/ENVIRONMENTAL PRECAUTIONS:

1. Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the elastomeric connection and cause display failure.
2. Mount the module so that it is free from torque and mechanical stress.
3. Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
4. Always employ anti-static procedure while handling the module.
5. Prevent moisture build-up upon the module and observe the environmental constraints for storage temperature and humidity.
6. Do not store in direct sunlight
7. If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap

10.5. Storage Precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

10.6. Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- Terminal electrode sections.

11. USING LCD MODULES

11.1. Liquid Crystal Display Modules

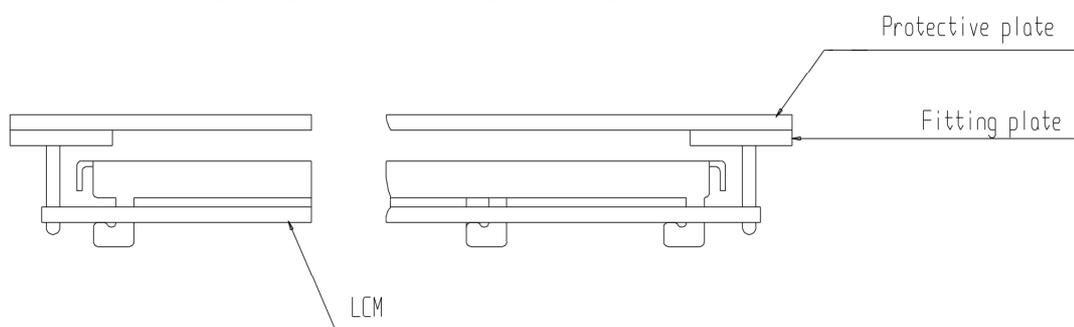
LCD is composed of glass and polarizer. Pay attention to the following items when handling.

1. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
2. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
3. N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
4. When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
5. Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
6. Avoid contacting oil and fats.
7. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
8. Do not put or attach anything on the display area to avoid leaving marks on.
9. Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
10. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

11.2. Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

1. Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



2. When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

11.3. Precaution for Handling LCD Modules

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the

module or making any alterations or modifications to it.

1. Do not alter, modify or change the shape of the tab on the metal frame.
2. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
3. Do not damage or modify the pattern writing on the printed circuit board.
4. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
5. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
6. Do not drop, bend or twist LCM.

11.4. Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

1. Make certain that you are grounded when handling LCM.
2. Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
3. When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
4. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
5. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
6. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

11.5. Precaution for soldering to the LCM

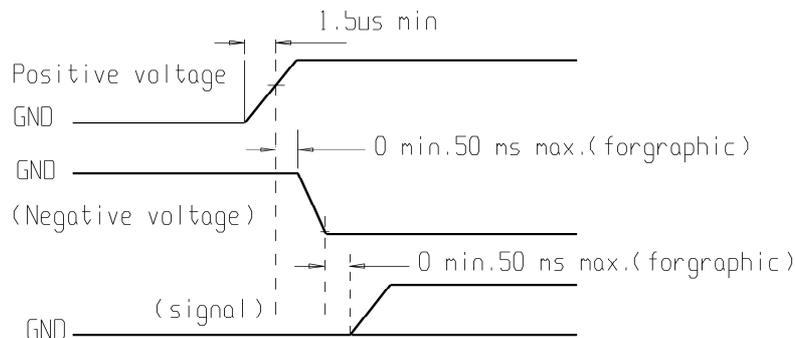
1. Observe the following when soldering lead wire, connector cable and etc. to the LCM.
 - Soldering iron temperature: 310°C ± 10°C.
 - Soldering time: 3-4 sec.
 - Solder: eutectic solder.

If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

2. When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
3. When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

11.6. Precautions for Operation

1. Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
2. Driving the LCD in the voltage above the limit shortens its life.
3. Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
4. If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
5. Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C , 50% RH.
6. When turning the power on, input each signal after the positive/negative voltage becomes stable.



11.7. Storage

When storing LCDs as spares for some years, the following precaution are necessary.

1. Store them in a sealed polyethylene bag. If properly sealed, there is no need for desiccant.
2. Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
3. The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
4. Environmental conditions :
 - Do not leave them for more than 168hrs. at 60°C.
 - Should not be left for more than 48hrs. at -20°C.

11.8. Safety

1. It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
2. If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

11.9. Limited Warranty

Unless agreed between DISPLAYTECH and customer, DISPLAYTECH will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with DISPLAYTECH LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to DISPLAYTECH within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DISPLAYTECH limited to repair and/or replacement on the terms set forth above. DISPLAYTECH will not be responsible for any subsequent or consequential events.

11.10. Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet's damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.